54ACT16827, 74ACT16827 20-BIT BUFFERS/DRIVERS WITH 3-STATE OUTPUTS

SCAS163A - JUNE 1990 - REVISED APRIL 1996

- Members of the Texas Instruments
 Widebus™ Family
- Inputs Are TTL-Voltage Compatible
- 3-State Outputs Drive Bus Lines Directly
- Flow-Through Architecture Optimizes
 PCB Layout
- Distributed V_{CC} and GND Pin Configuration Minimizes High-Speed Switching Noise
- EPIC™ (Enhanced-Performance Implanted CMOS) 1-μm Process
- 500-mA Typical Latch-Up Immunity at 125°C
- Package Options Include Plastic 300-mil Shrink Small-Outline (DL) Packages Using 25-mil Center-to-Center Pin Spacings and 380-mil Fine-Pitch Ceramic Flat (WD) Packages Using 25-mil Center-to-Center Pin Spacings

description

The 'ACT16827 are noninverting 20-bit buffers composed of two 10-bit sections with separate output-enable signals. For either 10-bit buffer section, the two output-enable (10E1 and 10E2 or 20E1 and 20E2) inputs must both be low for the corresponding Y outputs to be active. If either output-enable input is high, the outputs of that 10-bit buffer section are in the high-impedance state.

The 74ACT16827 is packaged in TI's shrink small-outline package, which provides twice the I/O pin count and functionality of standard small-outline packages in the same printed-circuit-board area.

54ACT16827 . . . WD PACKAGE 74ACT16827 . . . DL PACKAGE (TOP VIEW)



The 54ACT16827 is characterized for operation over the full military temperature range of –55°C to 125°C. The 74ACT16827 is characterized for operation from –40°C to 85°C.

FUNCTION TABLE (each 8-bit section)

	INPUTS		ОИТРИТ
OE1	OE2	Α	Y
L	L	L	L
L	L	Н	н
Н	X	Χ	Z
Х	Н	Χ	Z

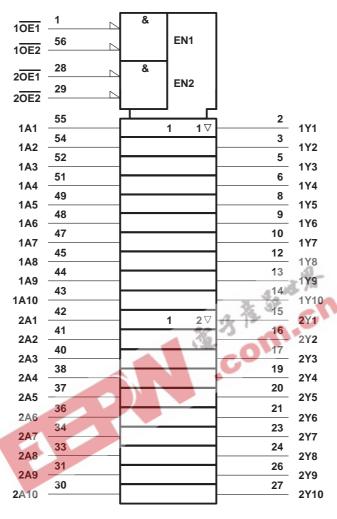


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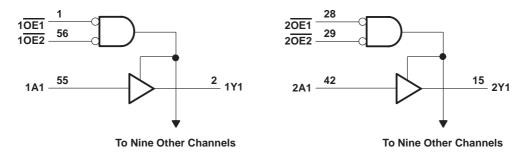


logic symbol†



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)





absolute maximum ratings over operating free-air temperature (unless otherwise noted)†

Supply voltage range, V _{CC}	–0.5 V to 7 V
Input voltage range, V _I (see Note 1)	$0.5 \text{ V to V}_{CC} + 0.5 \text{ V}$
Output voltage range, V _O (see Note 1)	$0.5 \text{ V to V}_{CC} + 0.5 \text{ V}$
Input clamp current, $I_{ K }$ ($V_{ C }$ or $V_{ C }$ $V_{ C }$)	±20 mA
Output clamp current, I _{OK} (V _O < 0 or V _O > V _{CC})	±50 mA
Continuous output current, I_O ($V_O = 0$ to V_{CC})	50 mA
Continuous current through V _{CC} or GND	±500 mA
Maximum package power dissipation at $T_A = 55^{\circ}C$ (in still air) (see Note 2): DL package	1.4 W
Storage temperature range, T _{stg}	-65° C to 150° C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions (see Note 3)

		54ACT16827	54ACT16827	UNIT
		MIN NOM MAX	MIN NOM	MAX
Vcc	Supply voltage	4.5 5 5. 5	4.5 5	5.5 V
VIH	High-level input voltage	2	2	V
VIL	Low-level input voltage	0.8		0.8 V
VI	Input voltage	0 VCC	0	V _{CC} V
Vo	Output voltage	0 V _{CC}	0	V _{CC} V
loh	High-level output current	-24		–24 mA
loL	Low-level output current	24		24 mA
Δt/Δν	Input transition rise or fall rate	0 10	0	10 ns/V
TA	Operating free-air temperature	- 55 125	-40	85 °C

NOTE 3: Unused inputs must be held high or low to prevent them from floating.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

 $^{2. \ \ \, \}text{The maximum package power dissipation is calculated using a junction temperature of } 150\,^{\circ}\text{C} \text{ and a board trace length of } 750\,\text{mils}.$

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DADAMETED	TEST CONDITIONS	V	T,	<u> </u> = 25°C		54ACT16827		74ACT16827		LINUT
PARAMETER	TEST CONDITIONS	vcc	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
	Jan - 50 u A	4.5 V	4.4			4.4		4.4		
	IOH = -50 μA	5.5 V	5.4			5.4		5.4		
Voн	Jan 24 mA	4.5 V	3.94			3.8		3.8		V
	$I_{OH} = -24 \text{ mA}$	5.5 V	4.94			4.8		4.8		
	$I_{OH} = -75 \text{ mA}^{\dagger}$	5.5 V				3.85	_	3.85		
	I _{OL} = 50 μA	4.5 V			0.1		0.1		0.1	٧
	ΙΟΣ = 50 μΑ	5.5 V			0.1		0.1		0.1	
VoL	lo 24 mA	4.5 V			0.36	4	0.44		0.44	
	I _{OL} = 24 mA	5.5 V			0.36	ζ),	0.44		0.44	
	I _{OL} = 75 mA [†]	5.5 V				20	1.65		1.65	
lį	V _I = V _{CC} or GND	5.5 V			±0.1	P.P.	±1		±1	μΑ
loz	V _O = V _{CC} or GND	5.5 V			±0.5	-	±5		±5	μΑ
lcc	$V_I = V_{CC}$ or GND, $I_O = 0$	5.5 V			8	75-	80		80	μΑ
ΔI _{CC} ‡	One input at 3.4 V, Other inputs at V _{CC} or GND	5.5 V		表	0.9	cn	1		1	mA
Ci	V _I = V _{CC} or GND	5 V	36	4.5	40					pF
Co	V _O = V _{CC} or GND	5 V	135	16	10.					pF

[†] Not more than one output should be tested at a time, and the duration of the test should not exceed 10 ms.

switching characteristics over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	то	T _A = 25°C			54ACT16827		74ACT16827		UNIT	
PARAMETER	(INPUT)	(OUTPUT)	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT	
t _{PLH}	^		3.6	7.4	9.8	3.6	11	3.6	11	ne	
t _{PHL}	A	Y	2.8	7.4	9.8	2.8	10.8	2.8	10.8	ns	
^t PZH	- -		V	3	7.9	10.4	3	11.7	3	11.7	ns
^t PZL	OE	ı	4	9.6	12.4	4	14	4	14	115	
t _{PHZ}	-		5.8	9.1	11.3	5.8	12.4	5.8	12.4	nc	
tPLZ	OE	ľ	5.3	8.5	10.5	5.3	11.5	5.3	11.5	ns	

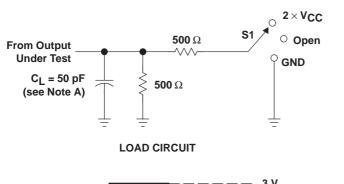
operating characteristics, V_{CC} = 5 V, T_A = 25°C

	PARAMETER	TEST CO	TYP	UNIT		
	Dower discinction conscitance	Outputs enabled	C 50 pE	f = 1 MHz	41	
Cpd	Power dissipation capacitance	Outputs disabled	$C_L = 50 \text{ pF},$	f = 1 MHz	10	p⊦

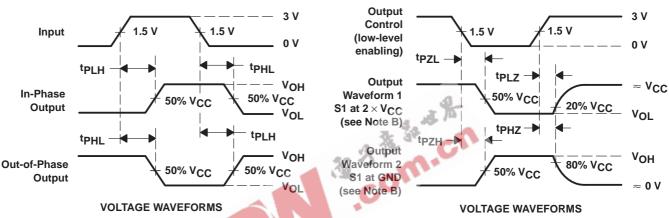


[‡]This is the increase in supply current for each input that is at one of the specified TTL voltage levels rather than 0 V or VCC.

PARAMETER MEASUREMENT INFORMATION



TEST	S 1
tPLH/tPHL	Open
tPLZ/tPZL	2×V _{CC}
tPHZ/tPZH	GND



NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, $Z_O = 50 \ \Omega$, $t_f = 3 \ ns$, $t_f = 3 \ ns$.
- D. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms



PACKAGE OPTION ADDENDUM

3-May-2005

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
74ACT16827DL	ACTIVE	SSOP	DL	56	20	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
74ACT16827DLR	ACTIVE	SSOP	DL	56	1000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

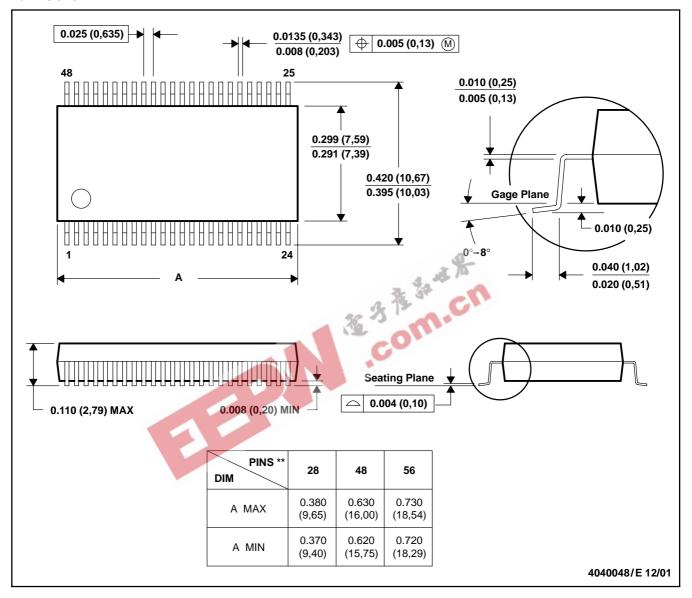
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DL (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

48 PINS SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MO-118

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Mailing Address: Texas Instruments

Post Office Box 655303 Dallas, Texas 75265

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